NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

Rev. 11 — 9 December 2011

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

NPN Resistor-Equipped Transistor (RET) family in Surface-Mounted Device (SMD) plastic packages.

#### Table 1. Product overview

Type number	Package	-			Package
	NXP	JEITA	JEDEC	complement	configuration
PDTC143XE	SOT416	SC-75	-	PDTA143XE	ultra small
PDTC143XM	SOT883	SC-101	-	PDTA143XM	leadless ultra small
PDTC143XT	SOT23	-	TO-236AB	PDTA143XT	small
PDTC143XU	SOT323	SC-70	-	PDTA143XU	very small

### 1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

#### **1.3 Applications**

- Digital applications in automotive and industrial segments
- Control of IC inputs

- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified
- Cost-saving alternative for BC847/857 series in digital applications
- Switching loads

#### 1.4 Quick reference data

#### Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	50	V
I <sub>O</sub>	output current		-	-	100	mA
R1	bias resistor 1 (input)		3.3	4.7	6.1	kΩ
R2/R1	bias resistor ratio		1.7	2.1	2.6	



NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

## 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
SOT23; S	SOT323; SOT416		
1	input (base)	_	
2	GND (emitter)	3	
3	output (collector)	2	1 R1 R2 sym007
SOT883			
1	input (base)		
2	GND (emitter)		
3	output (collector)	2 Transparent top view	1 R1 R2 Sym007

## 3. Ordering information

Type number	Package	ickage					
	Name	Description	Version				
PDTC143XE	SC-75	plastic surface-mounted package; 3 leads	SOT416				
PDTC143XM	SC-101	leadless ultra small plastic package; 3 solder lands; body 1.0 $\times$ 0.6 $\times$ 0.5 mm	SOT883				
PDTC143XT	-	plastic surface-mounted package; 3 leads	SOT23				
PDTC143XU	SC-70	plastic surface-mounted package; 3 leads	SOT323				

### 4. Marking

Table 5.   Marking codes	
Type number	Marking code <sup>[1]</sup>
PDTC143XE	34
PDTC143XM	E2
PDTC143XT	*32
PDTC143XU	*53

[1] \* = placeholder for manufacturing site code

# PDTC143X\_SER Product data sheet

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NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

### 5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	7	V
VI	input voltage				
	positive		-	+20	V
	negative		-	-7	V
lo	output current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 ms$	-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	PDTC143XE (SOT416)		[1][2] _	150	mW
	PDTC143XM (SOT883)		[2][3]	250	mW
	PDTC143XT (SOT23)		<u>[1]</u> -	250	mW
	PDTC143XU (SOT323)		<u>[1]</u> -	200	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

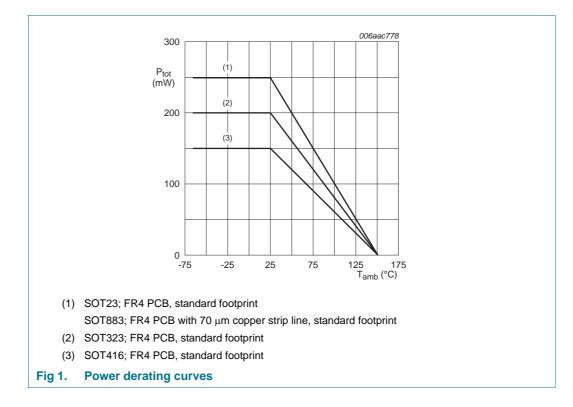
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70 µm copper strip line, standard footprint.

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NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 



### 6. Thermal characteristics

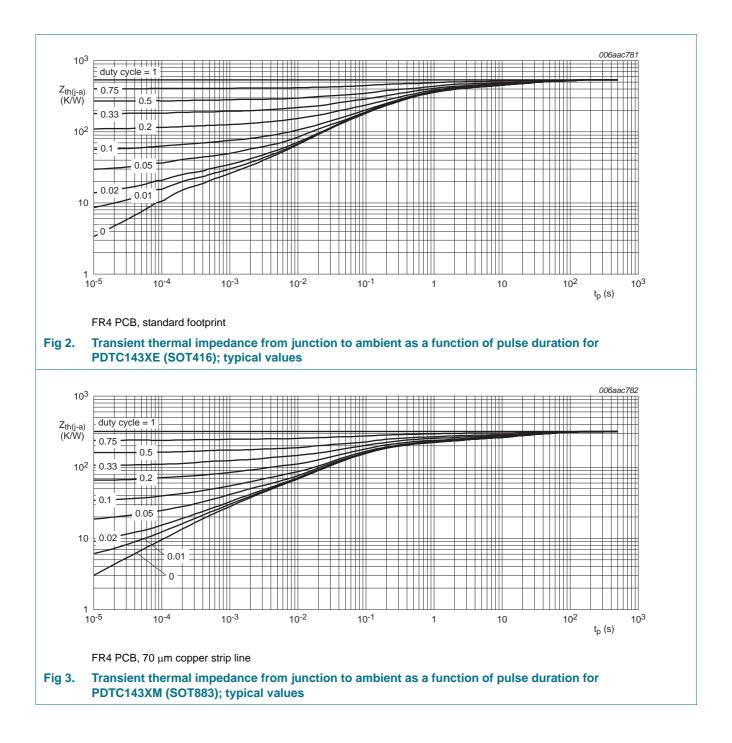
Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	PDTC143XE (SOT416)		[1][2]	-	830	K/W
	PDTC143XM (SOT883)		[2][3]	-	500	K/W
	PDTC143XT (SOT23)		<u>[1]</u> _	-	500	K/W
	PDTC143XU (SOT323)		<u>[1]</u> _	-	625	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

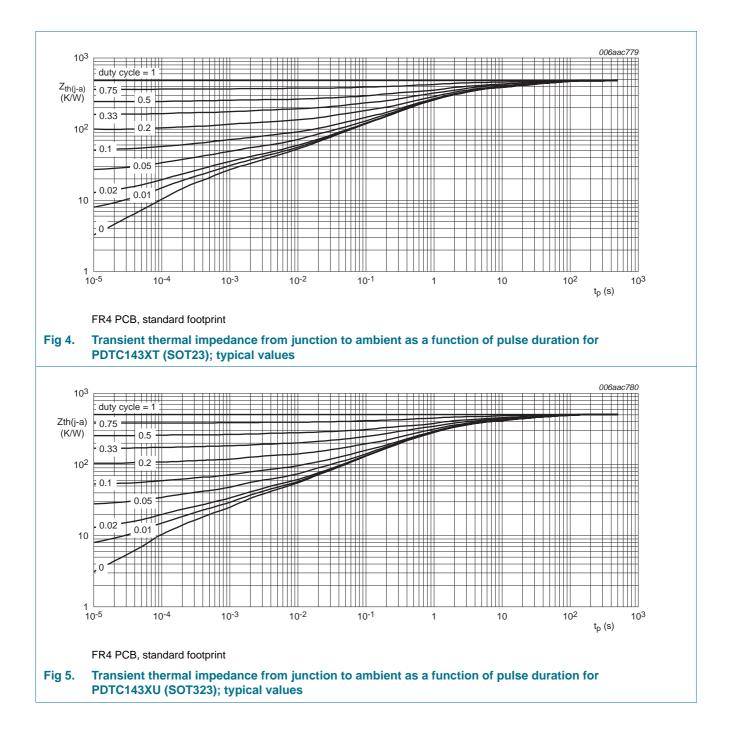
[2] Reflow soldering is the only recommended soldering method.

[3] Device mounted on an FR4 PCB with 70  $\mu$ m copper strip line, standard footprint.

# **PDTC143X series**



# **PDTC143X series**



NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

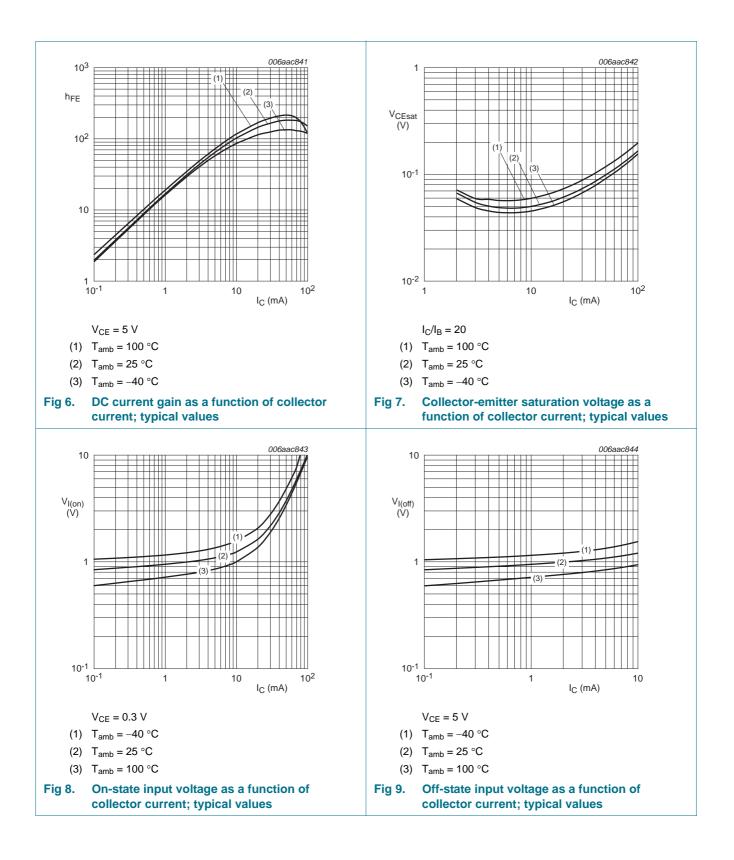
### 7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
I <sub>CEO</sub>	collector-emitter	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$		-	-	1	μA
	cut-off current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0 A; T <sub>j</sub> = 150 °C		-	-	5	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	600	μA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA}$		50	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{C}$ = 10 mA; $I_{B}$ = 0.5 mA		-	-	100	mV
V <sub>I(off)</sub>	off-state input voltage	$V_{CE}$ = 5 V; $I_C$ = 100 $\mu$ A		-	0.9	0.3	V
V <sub>I(on)</sub>	on-state input voltage	$V_{CE}$ = 0.3 V; $I_{C}$ = 20 mA		2.5	1.5	-	V
R1	bias resistor 1 (input)			3.3	4.7	6.1	kΩ
R2/R1	bias resistor ratio			1.7	2.1	2.6	
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz		-	-	2.5	pF
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 10 mA; f = 100 MHz	<u>[1]</u>	-	230	-	MHz

[1] Characteristics of built-in transistor

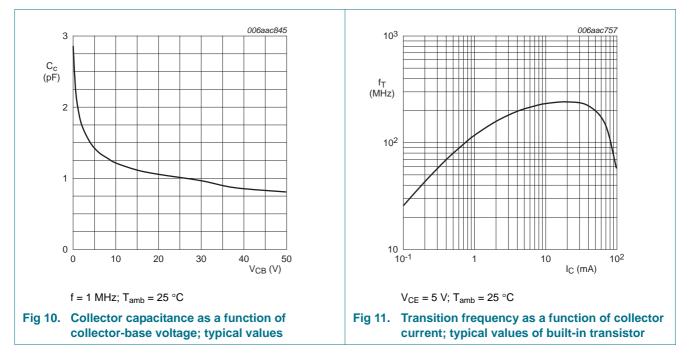
PDTC143X\_SER
Product data sheet

# **PDTC143X series**



# **PDTC143X series**

NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 



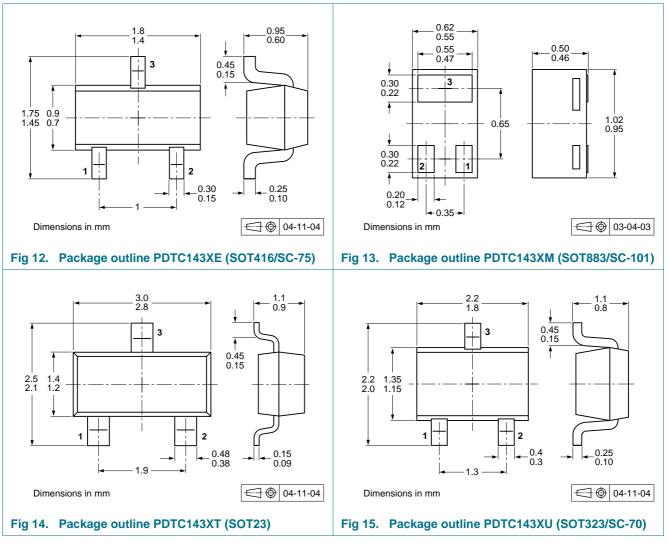
### 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

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#### **Package outline** 9.



### **10. Packing information**

#### Table 9. **Packing methods**

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

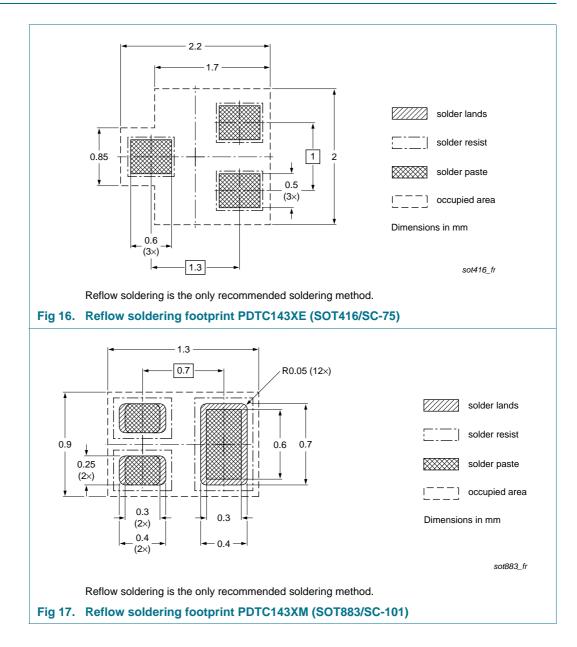
Type number	Package	Description	Packing	Packing quantity		
			3000	5000	10000	
PDTC143XE	SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-135	
PDTC143XM	SOT883	2 mm pitch, 8 mm tape and reel	-	-	-315	
PDTC143XT	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235	
PDTC143XU	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135	

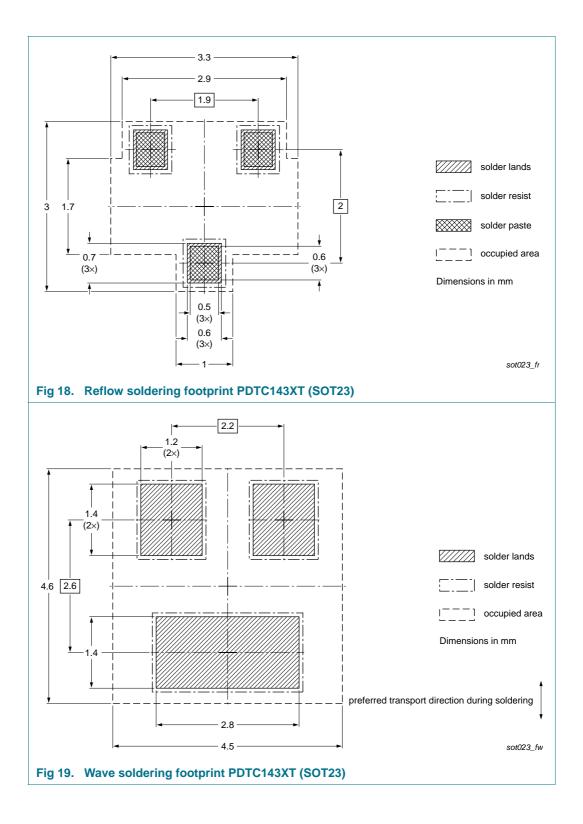
[1] For further information and the availability of packing methods, see Section 14.

PDTC143X\_SER Product data sheet

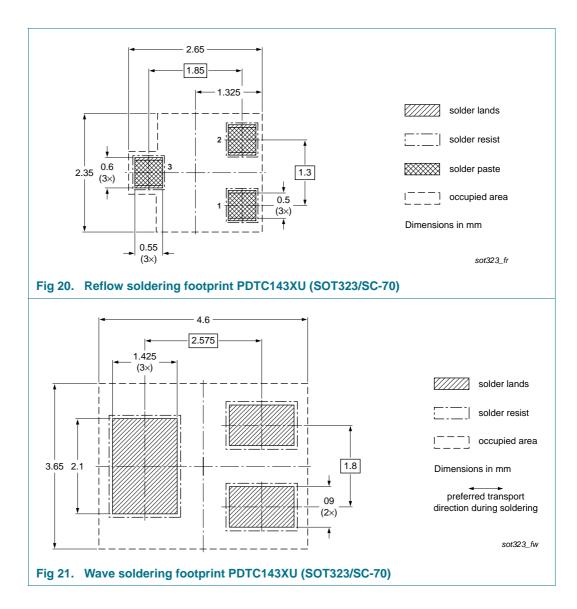
NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

### 11. Soldering





NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 



PDTC143X\_SER
Product data sheet

NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

### 12. Revision history

#### Table 10.Revision history

PDTC143X_SER v.11       20111209       Product data sheet       -       PDTC143X_SER         Modifications:       • Type numbers PDTC143XEF, PDTC143XK and PDTC143XS removed.       • Section 1 "Product profile": updated       • Section 2 "Pinning information": updated       • Section 2 "Pinning information": updated       • Section 4 "Marking": updated       • Section 4 "Marking": updated       • Section 4 "Marking": updated       • Section 6 "Thermal characteristics": updated       • Figure 1 to 5, 10 and 11: added       • Section 6 "Thermal characteristics": updated       • Figure 6 to 9: updated       • Figure 6 to 9: updated       • Section 8 "Test information": added       • Section 11 "Soldering": added       • Section 11 "Soldering": added       • Section 11 "Soldering": updated       • Section 13 "Legal information": updated       • PDTC143X_SER         PDTC143X_SERIES v.10       20091116       Product data sheet       -       PDTC143X_SER	RIES v.10
<ul> <li>Section 1 "Product profile": updated</li> <li>Section 2 "Pinning information": updated</li> <li>Section 4 "Marking": updated</li> <li>Figure 1 to 5, 10 and 11: added</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
<ul> <li>Section 2 "Pinning information": updated</li> <li>Section 4 "Marking": updated</li> <li>Figure 1 to 5, 10 and 11: added</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
<ul> <li>Section 4 "Marking": updated</li> <li>Figure 1 to 5, 10 and 11: added</li> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
Figure 1 to 5, 10 and 11: added         Section 6 "Thermal characteristics": updated         Figure 6 to 9: updated         Table 8 "Characteristics": V <sub>I(on)</sub> and V <sub>I(off)</sub> updated, I <sub>CEO</sub> updated, f <sub>T</sub> added         Section 8 "Test information": added         Section 11 "Soldering": added         Section 13 "Legal information": updated         PDTC143X_SERIES v.10       20091116	
<ul> <li>Section 6 "Thermal characteristics": updated</li> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10</li> </ul>	
<ul> <li>Figure 6 to 9: updated</li> <li>Table 8 "Characteristics": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li>Section 8 "Test information": added</li> <li>Section 11 "Soldering": added</li> <li>Section 13 "Legal information": updated</li> <li>PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
<ul> <li><u>Table 8 "Characteristics</u>": V<sub>I(on)</sub> and V<sub>I(off)</sub> updated, I<sub>CEO</sub> updated, f<sub>T</sub> added</li> <li><u>Section 8 "Test information</u>": added</li> <li><u>Section 11 "Soldering</u>": added</li> <li><u>Section 13 "Legal information</u>": updated</li> <li><u>PDTC143X_SERIES v.10</u> 20091116 Product data sheet - PDTC143X_SERIES</li> </ul>	
Section 8 "Test information": added     Section 11 "Soldering": added     Section 13 "Legal information": updated  PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 PDTC143Y_SERIES v.10 PDTC143Y_SER	
Section 11 "Soldering": added     Section 13 "Legal information": updated  PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 PDTC143Y_SERIES v.10 PDTC143Y_SERIES v.10 PDTC143Y_SERIES	
Section 13 "Legal information": updated  PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 Product data sheet - PDTC143X_SERIES v.10 20091116 PDTC143X_SERIES v.10 PDTC143X_SERIE	
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PDTC143X_SERIES v.7 20040323 Product specification - PDTC143X_SE	RIES v.6
PDTC143X_SERIES v.6 20040112 Product specification - PDTC143X_SE	RIES v.5
PDTC143X_SERIES v.5 20031112 Product specification - PDTC143X_SE	
PDTC143X_SERIES v.4 20030910 Product specification - PDTC143X_SE	
PDTC143X_SERIES v.3 20030410 Product specification	RIES v.4

### **13. Legal information**

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

#### NPN resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$ , $R2 = 10 \text{ k}\Omega$

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**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

### 14. Contact information

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# **PDTC143X series**

NPN resistor-equipped transistors; R1 = 4.7 k $\Omega$ , R2 = 10 k $\Omega$ 

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